

P-Channel 20-V (D-S) MOSFET

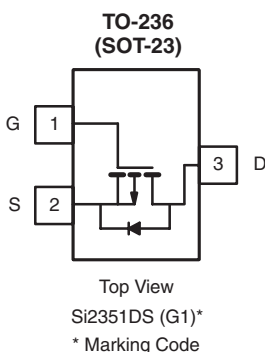
MOSFET PRODUCT SUMMARY			
V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A) ^a	Q_g (Typ.)
- 20	0.115 at $V_{GS} = - 4.5$ V	- 3.0	3.2 nC
	0.205 at $V_{GS} = - 2.5$ V	- 2.2	

FEATURES

- Halogen-free Option Available
- TrenchFET[®] Power MOSFET
- PWM Optimized
- 100 % R_g Tested



RoHS
COMPLIANT



Ordering Information: Si2351DS-T1-E3 (Lead (Pb)-free)
Si2351DS-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted				
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V_{DS}	- 20	V
Gate-Source Voltage		V_{GS}	± 12	
Continuous Drain Current ($T_J = 150$ °C)	$T_C = 25$ °C	I_D	- 2.8	A
	$T_C = 70$ °C		- 2.4	
	$T_A = 25$ °C		- 2.2 ^{b, c}	
	$T_A = 70$ °C		- 1.8 ^{b, c}	
Pulsed Drain Current		I_{DM}	- 10	
Continuous Source-Drain Diode Current	$T_C = 25$ °C	I_S	- 2.0	A
	$T_A = 25$ °C		- 0.91 ^{b, c}	
Maximum Power Dissipation	$T_C = 25$ °C	P_D	2.1	W
	$T_C = 70$ °C		1.5	
	$T_A = 25$ °C		1.0 ^{b, c}	
	$T_A = 70$ °C		0.7 ^{b, c}	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{b, d}	≤ 5 s	R_{thJA}	90	115	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	60	75	

Notes:

- Based on $T_C = 25$ °C.
- Surface Mounted on 1" x 1" FR4 board.
- $t = 5$ s.
- Maximum under Steady State conditions is 130 °C/W.

MOSFET SPECIFICATIONS T _J = 25 °C, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	V _{DS} = 0 V, I _D = - 250 μA	- 20			V
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	I _D = - 250 μA		- 16.7		mV/°C
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)} /T _J			2.1		
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = - 250 μA	- 0.6		- 1.5	V
Gate-Source Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 12 V			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V			- 1	μA
		V _{DS} = - 20 V, V _{GS} = 0 V, T _J = 55 °C			- 10	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≥ - 5 V, V _{GS} = - 4.5 V	- 10			A
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 2.4 A		0.092	0.115	Ω
		V _{GS} = - 2.5 V, I _D = - 1.8 A		0.164	0.205	
Forward Transconductance ^a	g _{fs}	V _{DS} = - 10 V, I _D = - 2.4 A		5.5		S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{DS} = - 10 V, V _{GS} = 0 V, f = 1 MHz		250		pF
Output Capacitance	C _{oss}			80		
Reverse Transfer Capacitance	C _{rss}			55		
Total Gate Charge	Q _g	V _{DS} = - 10 V, V _{GS} = - 5.0 V, I _D = - 2.4 A		3.4	5.1	nC
		V _{DS} = - 10 V, V _{GS} = - 4.5 V, I _D = - 2.4 A		3.2	5	
Gate-Source Charge	Q _{gs}			0.5		
Gate-Drain Charge	Q _{gd}			1.4		
Gate Resistance	R _g	f = 1 MHz		8.5	13	Ω
Turn-On Delay Time	t _{d(on)}	V _{DD} = - 10 V, R _L = 5.26 Ω I _D ≅ - 1.9 A, V _{GEN} = - 4.5 V, R _G = 1 Ω		9	14	ns
Rise Time	t _r			30	45	
Turn-Off Delay Time	t _{d(off)}			32	48	
Fall Time	t _f			16	24	
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 2.0	A
Pulse Diode Forward Current ^a	I _{SM}				- 10	
Body Diode Voltage	V _{SD}	I _S = - 2.0 A		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t _{rr}	I _F = - 2.0 A, di/dt = 100 A/μs, T _J = 25 °C		17	26	ns
Body Diode Reverse Recovery Charge	Q _{rr}			5	8	nC
Reverse Recovery Fall Time	t _a			14		ns
Reverse Recovery Rise Time	t _b			3		

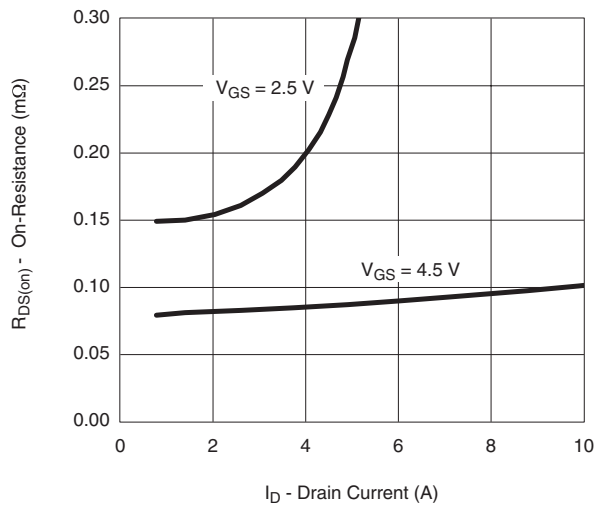
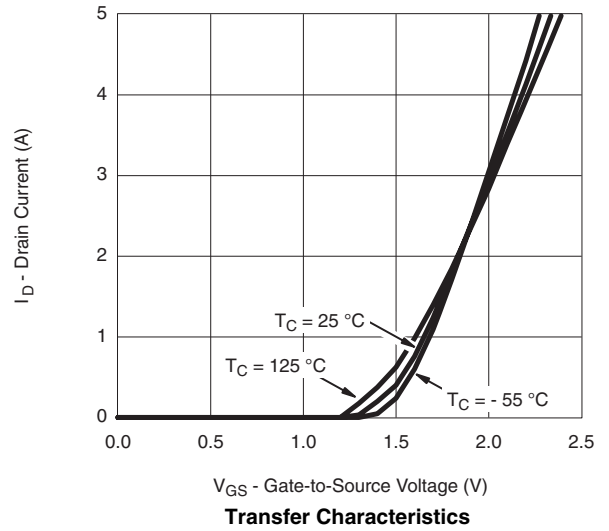
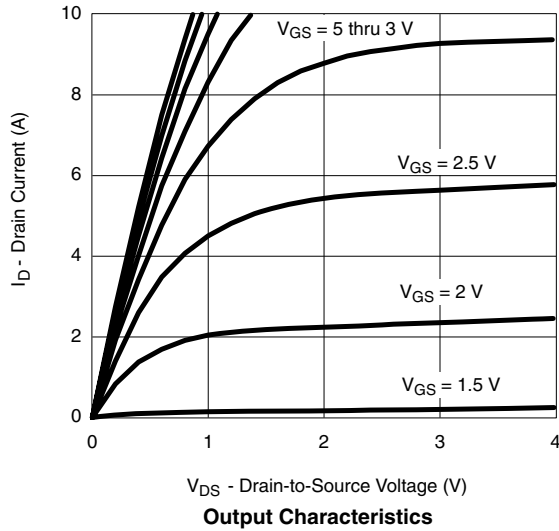
Notes:

a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

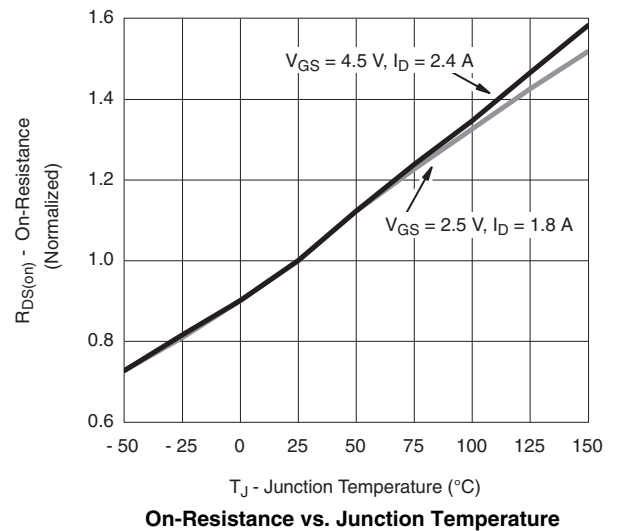
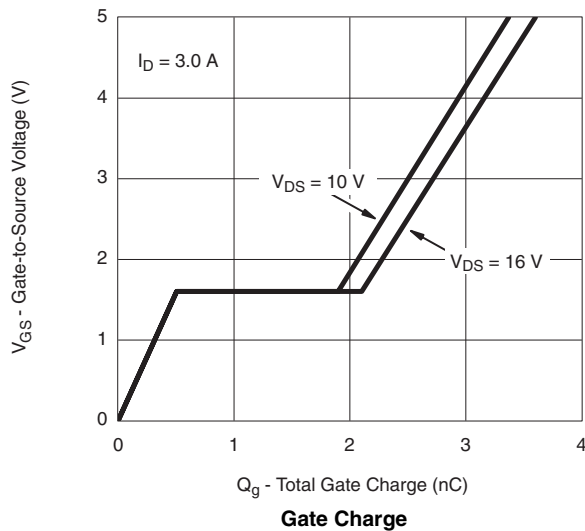
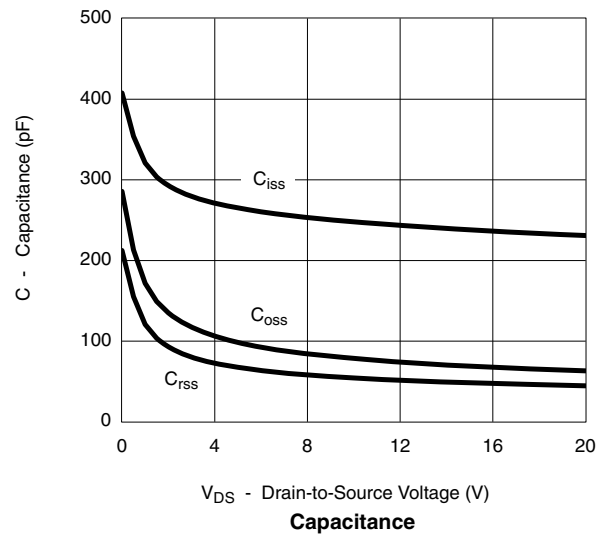
b. Guaranteed by design, not subject to production testing.

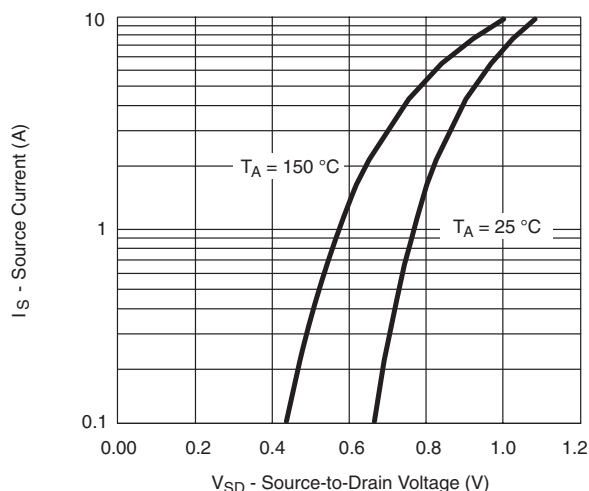
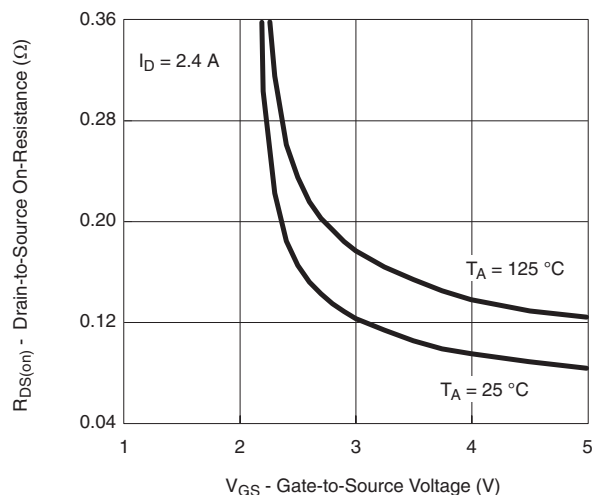
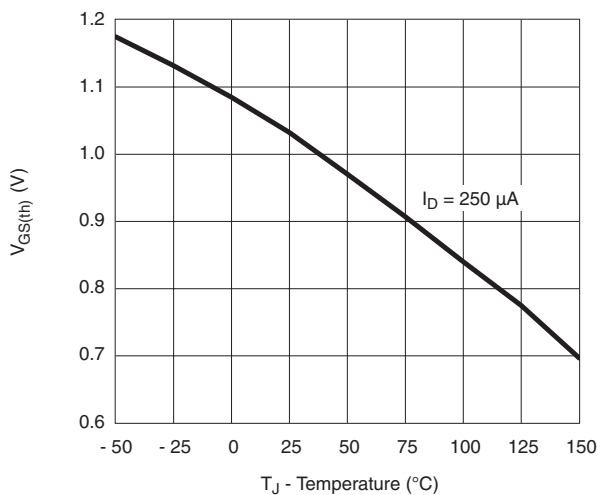
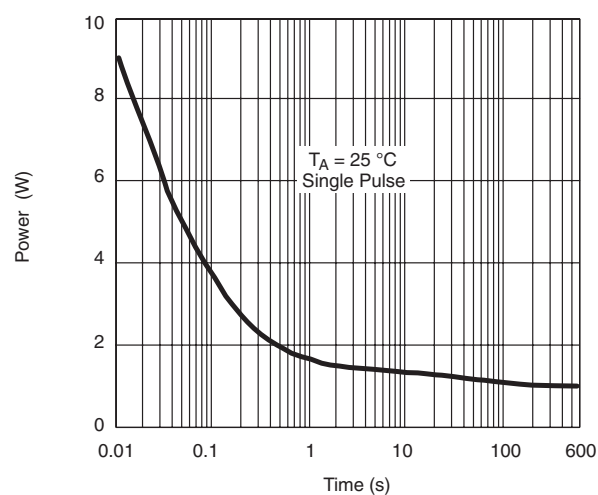
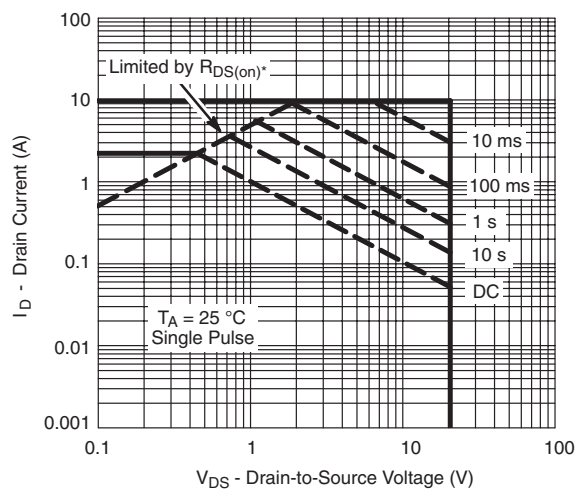
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

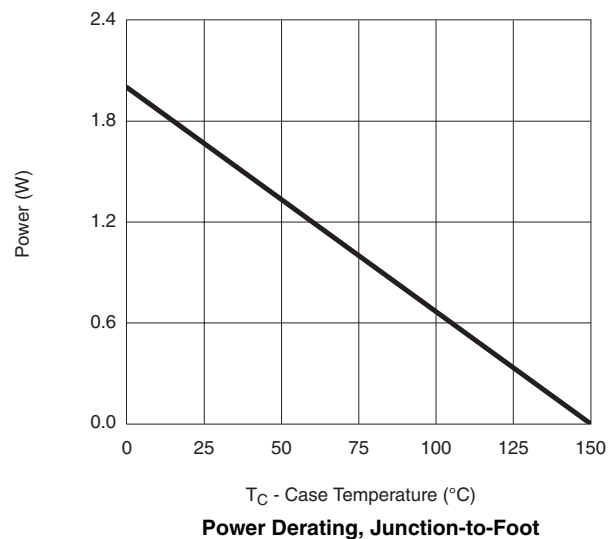
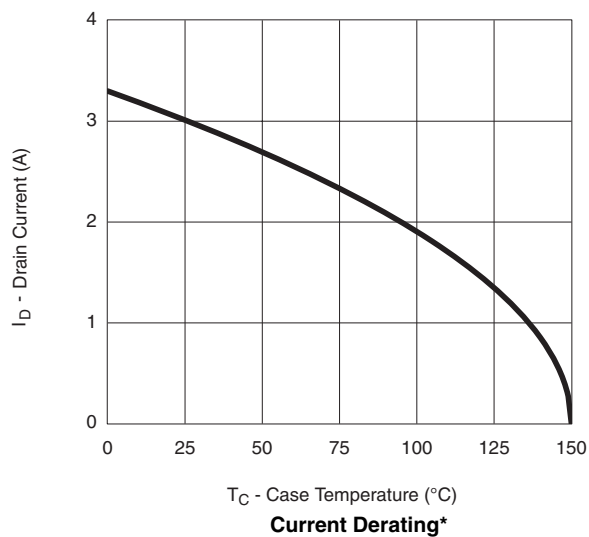


On-Resistance vs. Drain Current and Gate Voltage

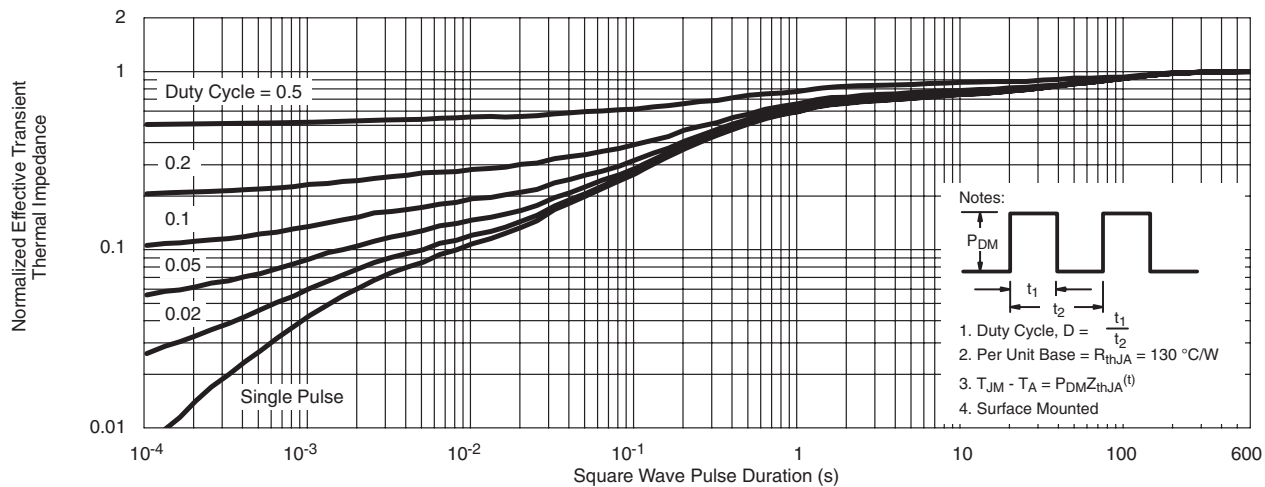
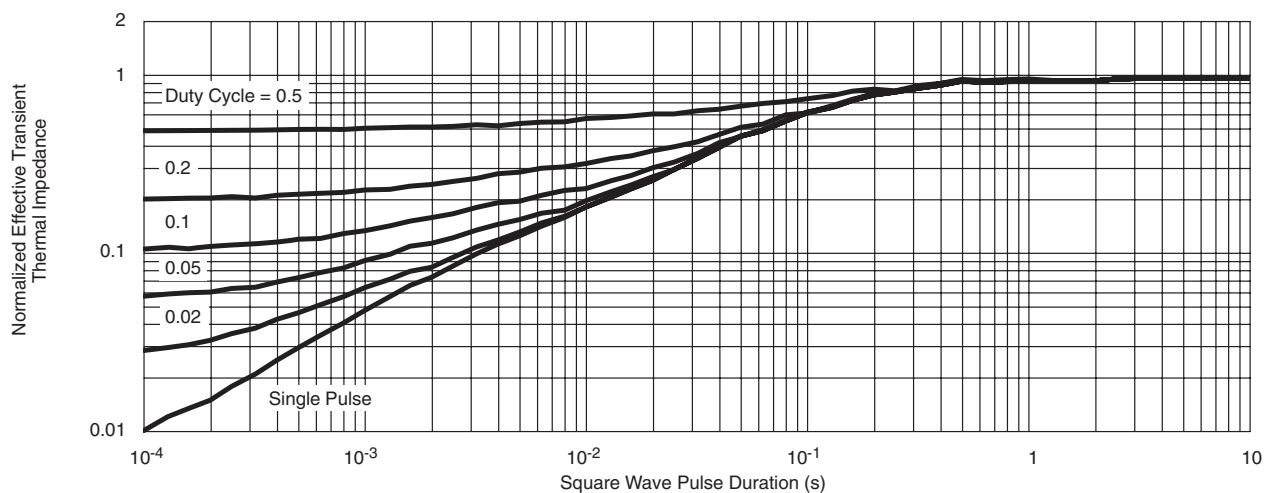


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted**Source-Drain Diode Forward Voltage****On-Resistance vs. Gate-to-Source Voltage****Threshold Voltage****Single Pulse Power*** $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified**Safe Operating Area**

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted**Normalized Thermal Transient Impedance, Junction-to-Ambient****Normalized Thermal Transient Impedance, Junction-to-Foot**

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